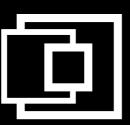
# Osai Automation Systems

# OSAI A.S. S.p.A. SB

Via Cartiera, 4 - 10010 Parella (TO) - ITALY Tel: +39 0125 66.83.11

sales@osai-as.com - www.osai-as.com





Modular • Configurable • Scalable • Reusable

# **PICK & PLACE**



This equipment is used to assemble different parts of power modules such as: dice, lead frame, preform and plastic case.

#### **KEYPOINTS**

#### Suitable for:

Dice, Preform, AMB, Lead Frame, Plastic Case

#### Configurable Input Media

Tray, Blister, Tape & Reel, Bulk, Film Frame

#### High Accuracy

±5µm

### High Speed

Up to 1sec/cycle



## PIN INSERTION



This equipment is used to place the pins on the substrate. It works for both wired (inserted) and coil pins (punched and soldered in the next phase).

#### **KEYPOINTS**

#### Suitable for:

Wired Pins and Coil Pins

#### High Accuracy

±5µm

#### Pin Insertion Check

Height ±50µm

#### Force Control Up to 500N

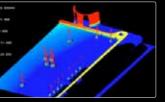
#### High Speed Up to 2pins/s

### **Optical Features**

Single Pin Optical Alignment

3D Scan Check





# DISPENSING / VACUUM POTTING



This equipment can be configured with: glue, flux jet dispenser (with integrated optical check and UV curing) or SilGel dispenser (two components volumetric dispenser) with vacuum potting chamber.

#### **KEYPOINTS**

#### Suitable for:

Ultra Fast Jet Dispensing / Two Components Volumetric Dispensing

#### Design for:

Flux, Glue and SilGel

#### High Accuracy

±5µm

#### **Optical Features**

UV Lighting Vision System Long Life LED UV Curing

# High Speed

Up to 300PH

#### **Additional Features**

Vacuum Potting Chamber Weight Check





# SOLDERING / WELDING



According to the connection method, the equipment can be configured to perform Vacuum induction soldering or ultrasonic welding.

#### KEYPOINTS

#### Suitable for:

Lead Frame Welding / Pin Soldering

#### High Accuracy

±5µm

#### Top notch technology

Linear or Torsional Ultrasonic Welding Patented Vacuum Induction Soldering

#### Optical Features

Full Optical Alignment Quality Optical Inspection

# LASER MARKING



The equipment is used to mark every single leadframe / AMB and device, to allow each single unit traceability. The green Laser source is the ultimate solution for a fast and accurate marking on copper, silver, ceramic substrate and plastic case.

#### KEYPOINTS

# LASER

Green

### Fiducial check

For accurate marking position

#### 100% data and grading check

On 1D/2D code

#### Optical check

For component presence/absence

#### Full library

(2D code, Bar code, QR code and others)

#### Tailored DB communication

For traceability





